

Electronic Patent Application Fee Transmittal

Application Number:	10522840
Filing Date:	27-Jan-2005
Title of Invention:	Method and apparatus for injection foaming molding
First Named Inventor/Applicant Name:	Tatsuya Tanaka
Filer:	Marvin Jay Spivak/Shawn Berry
Attorney Docket Number:	265044US0PCT
Filed as Large Entity	

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1615	2	50	100

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	460	460
Miscellaneous:				
Total in USD (\$)				560